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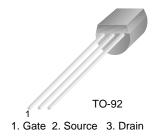
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September 2007

# 2N5950 N-Channel RF Amplifier

- · This device is designed primarily for electronic switching applications such as low on resistance analog switching.
- · Sourced from process 50.



# Absolute Maximum Ratings\* T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{DG}$	Drain-Gate Voltage	30	V
$V_{GS}$	Gate-Source Voltage	-30	V
$I_{GF}$	Forward Gate Current	10	mA
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 ~ 150	°C

<sup>\*</sup> This ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES

These rating are based on a maximum junction temperature of 150 degrees C.

# **Thermal Characteristics** T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

<sup>2)</sup> These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

# $\textbf{Electrical Characteristics*} \ \, \textbf{T}_{a} = 25^{\circ}\textbf{C} \ \, \textbf{unless otherwise noted}$

	Symbol	Parameter	Test Condition	Min.	Max.	Units
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### **Off Characteristics**

V <sub>(BR)GSS</sub>	Gate-Source Breakdown Voltage	$I_G = 1.0 \mu A, V_{DS} = 0$	-30		V
1	Gate Reverse Current	$V_{GS} = 25V, V_{DS} = 0, T = 25^{\circ}C$		-1.0	nA
IGSS		T = 100°C		-200	nA
V <sub>GS(off)</sub>	Gate-Source Cut-off Voltage	V <sub>DS</sub> = 15V, I <sub>D</sub> = 100nA	-2.5	-6.0	V
V <sub>GS(f)</sub>	Gate-Source Forward Voltage	I <sub>G</sub> = 1.0mA		1.0	V
$V_{GS}$	Gate-Source Forward Voltage	$V_{DS} = 15V$ , $I_D = 1mA$	-1.8	-5.0	V

## On Characteristics

*I <sub>DSS</sub>	Zero-Gate Voltage Drain Current *	$V_{DS} = 15V, V_{GS} = 0$	10	15	mA
Ros(on)	Drain-Source On Resistance	$I_D = 476\mu A, f = 1.0kHz$		210	Ω

## **Small Signal Characteristics**

gfs	Forward Transferconductance	$V_{DS} = 15V, V_{GS} = 0V, f = 100MHz$ $V_{DS} = 15V, V_{GS} = 0V, f = 1kHz$	3000 3500	7500	μ/Ω
Ciss	Input Capacitance	$V_{DS} = 15V, V_{GS} = 0V, f = 1.0MHz$		6	pF
Crss	Reverse Transfer Capacitance	$V_{DS} = 15V, V_{GS} = 0V, f = 1.0MHz$		2	pF

<sup>\*</sup> Pulse Test: Pulse Width ≤ 300μs, Duty Cycle = 2%





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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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Rev. I30